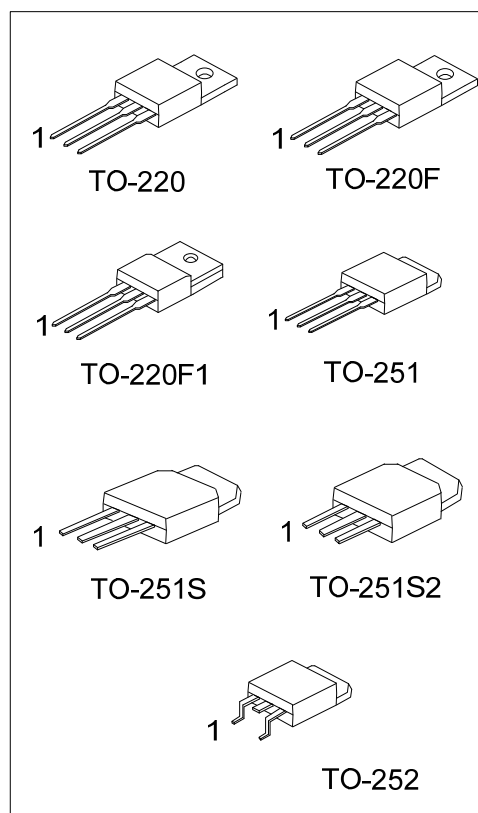
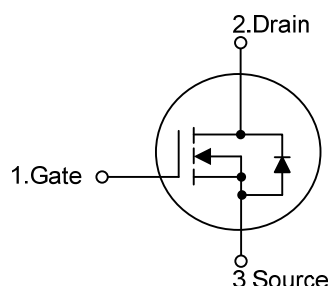


**11NM70-U2****Power MOSFET****11A, 700V N-CHANNEL
SUPER-JUNCTION MOSFET****DESCRIPTION**

The UTC 11NM70-U2 is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

FEATURES

- * $R_{DS(ON)} \leq 0.6 \Omega$ @ $V_{GS}=10V$, $I_D=1.2A$
- * High switching Speed
- * 100% avalanche tested
- * Improved dv/dt capability

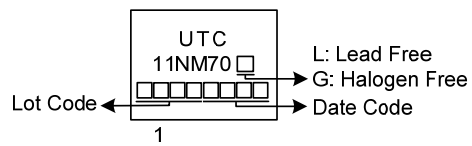
SYMBOL**ORDERING INFORMATION**

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
11NM70L-TA3-T	11NM70G-TA3-T	TO-220	G	D	S	Tube
11NM70L-TF1-T	11NM70G-TF1-T	TO-220F1	G	D	S	Tube
11NM70L-TF3-T	11NM70G-TF3-T	TO-220F	G	D	S	Tube
11NM70L-TM3-T	11NM70G-TM3-T	TO-251	G	D	S	Tube
11NM70L-TMS-T	11NM70G-TMS-T	TO-251S	G	D	S	Tube
11NM70L-TMS2-T	11NM70G-TMS2-T	TO-251S2	G	D	S	Tube
11NM70L-TN3-R	11NM70G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

11NM70G-TA3-T	(1)Packing Type	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF1: TO-220F1, TF3: TO-220F, TM3: TO-251, TMS: TO-251S, TMS2: TO-251S2 TN3: TO-252 (3) G: Halogen Free and Lead Free, L: Lead Free
	(2)Package Type	
	(3)Green Package	

■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DS}	700	V
Gate-Source Voltage		V_{GS}	± 30	V
Drain Current	Continuous	I_D	11	A
	Pulsed (Note 2)	I_{DM}	22	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	190	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	9	V/ns
Power Dissipation	TO-220	P_D	70	W
	TO-220F/TO-220F1		25	W
	TO-251/TO-251S		55	W
	TO-251S2/TO-252			
Junction Temperature		T_J	+150	$^\circ\text{C}$
Storage Temperature Range		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L=66\text{mH}$, $I_{AS}=2.4\text{ A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$

4. $I_{SD}\leq 11\text{A}$, $di/dt\leq 100\text{A}/\mu\text{s}$, $V_{DD}\leq BV_{DSS}$, Starting $T_J=25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F TO-220F1	θ_{JA}	62.5	°C/W
	TO-251/TO-251S TO-251S2/TO-252		110	
Junction to Case	TO-220	θ_{JC}	1.78	°C/W
	TO-220F/TO-220F1		5	
	TO-251/TO-251S TO-251S2/TO-252		2.27 (Note)	

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

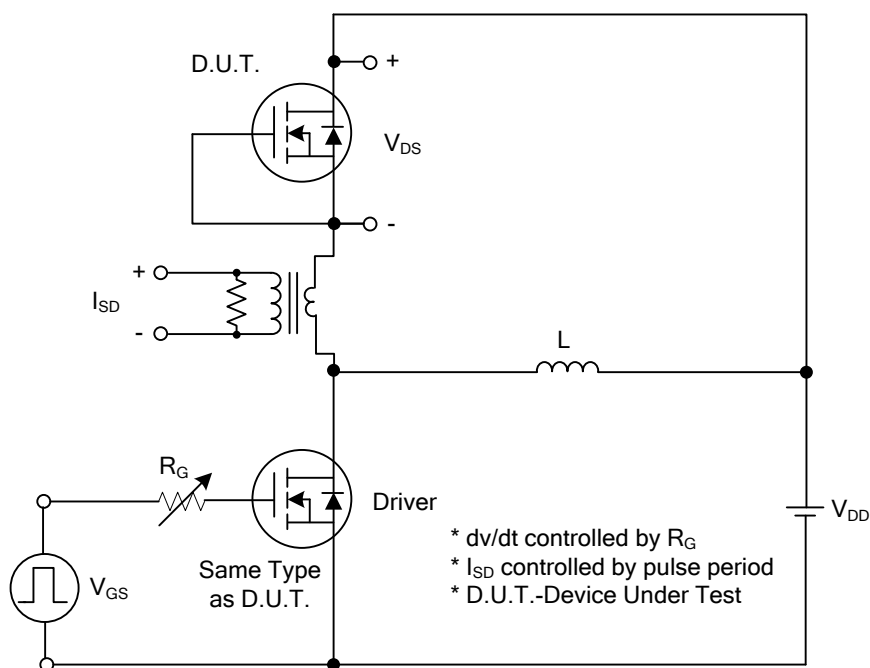
■ **ELECTRICAL CHARACTERISTICS** ($T_J=25^{\circ}\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250μA	700			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =700V, V _{GS} =0V			10	μA
Gate-Source Leakage Current	Forward	I _{GSS}	V _{DS} =0V ,V _{GS} =30V			100	nA
	Reverse		V _{DS} =0V ,V _{GS} =-30V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} = V _{GS} , I _D =250μA	2.5		4.5	V
Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =1.2A		0.56	0.6	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C _{ISS}	V _{GS} =0V, V _{DS} =50V, f=1.0MHz		600		pF
Output Capacitance		C _{OSS}			55		pF
Reverse Transfer Capacitance		C _{RSS}			4		pF
Gate Resistance		R _G	V _{DS} =0V, f =1MHz		2		Ω
SWITCHING PARAMETERS							
Total Gate Charge (Note 1)		Q _G	V _{DS} =100V, V _{GS} =10V, I _D =11A , I _G =1mA (Note 1, 2)		23.6		nC
Gate to Source Charge		Q _{GS}			7.6		nC
Gate to Drain Charge		Q _{GD}			8.3		nC
Turn-ON Delay Time (Note 1)		t _{D(ON)}	V _{DD} =100V, V _{GS} =10V, I _D =11A, R _G =25Ω (Note 1, 2)		10.5		ns
Rise Time		t _R			23		ns
Turn-OFF Delay Time		t _{D(OFF)}			63		ns
Fall-Time		t _F			44		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I _S				11	A
Maximum Body-Diode Pulsed Current		I _{SM}				22	A
Drain-Source Diode Forward Voltage (Note 1)		V _{SD}	I _S =11A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)		t _{rr}	I _S =11A, V _{GS} =0V,		250		ns
Body Diode Reverse Recovery Charge		Q _{rr}	dl _F /dt=100A/μs		2.36		μC

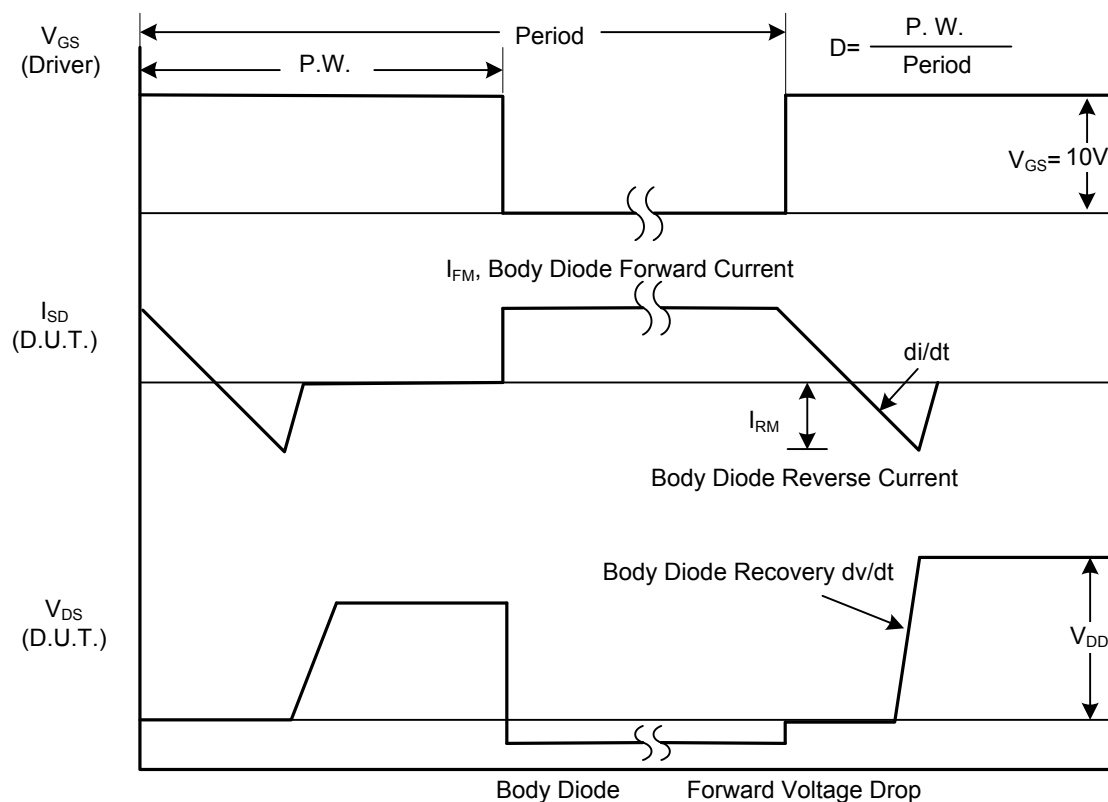
Notes: 1. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

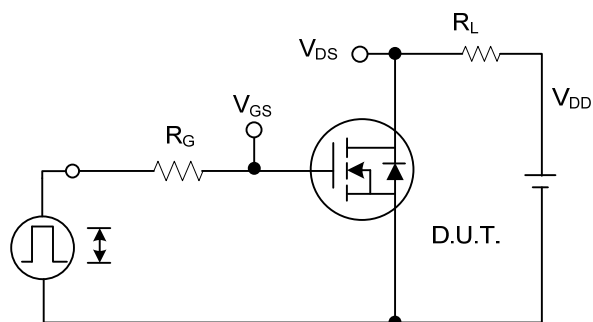


Peak Diode Recovery dv/dt Test Circuit

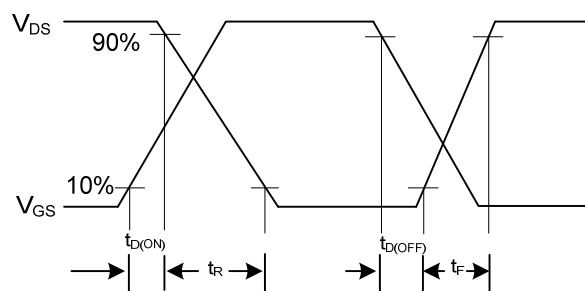


Peak Diode Recovery dv/dt Waveforms

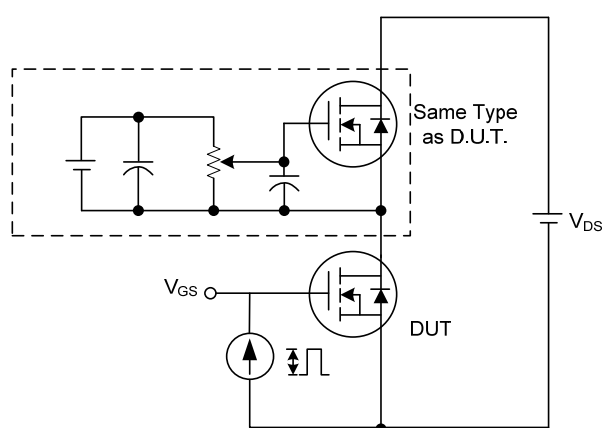
■ TEST CIRCUITS AND WAVEFORMS



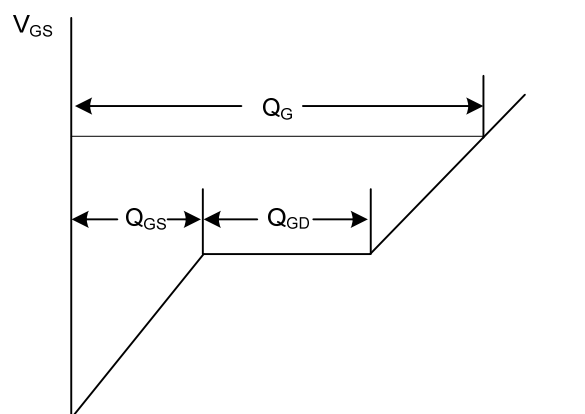
Switching Test Circuit



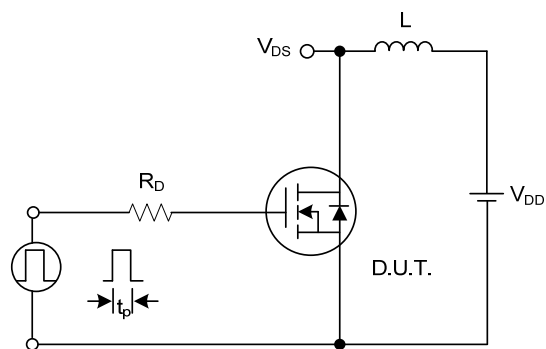
Switching Waveforms



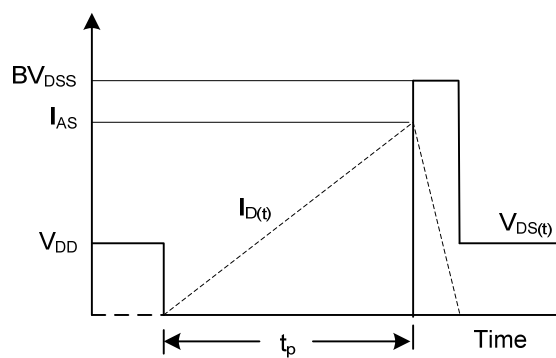
Gate Charge Test Circuit



Charge
Gate Charge Waveform

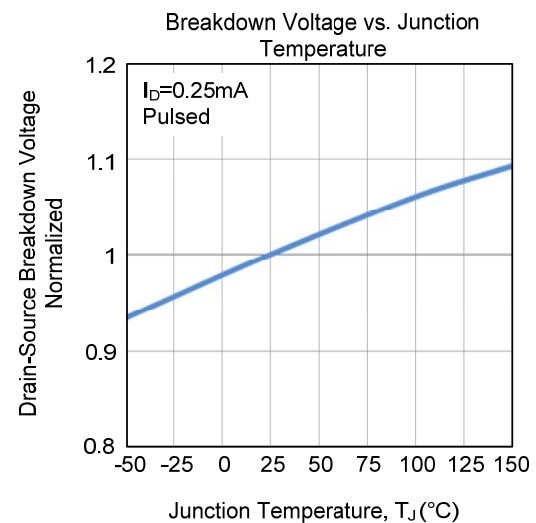
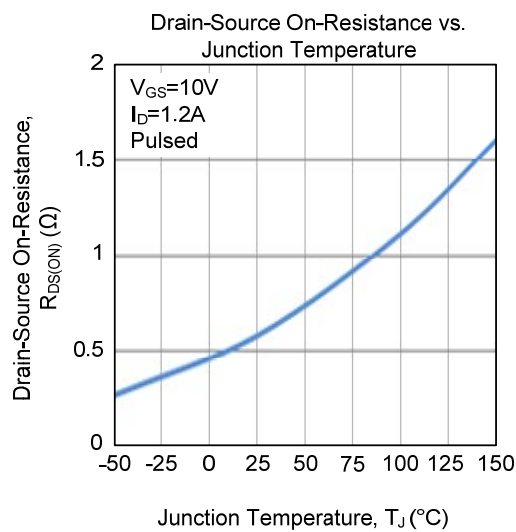
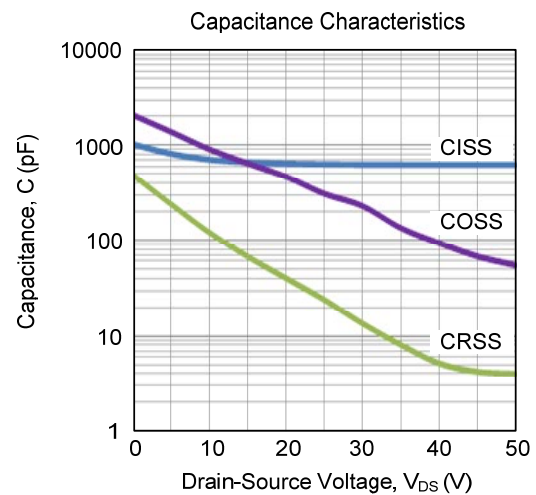
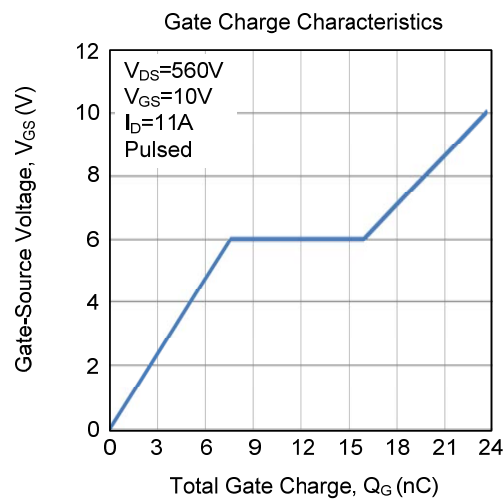
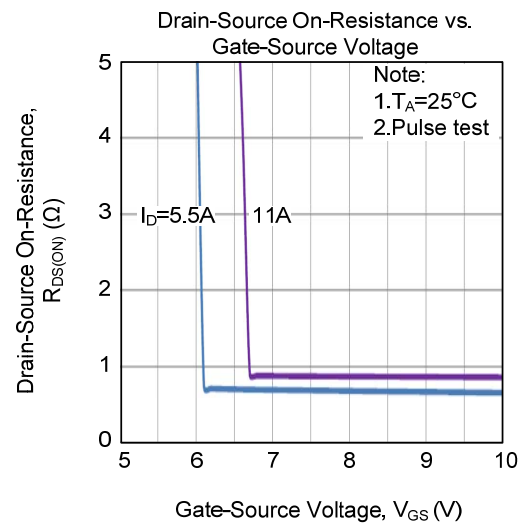
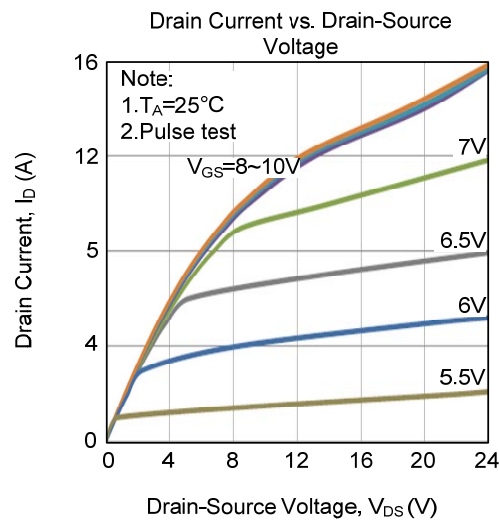


Unclamped Inductive Switching Test Circuit

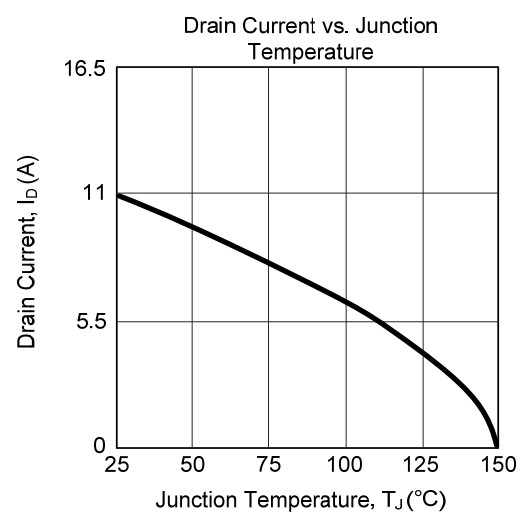
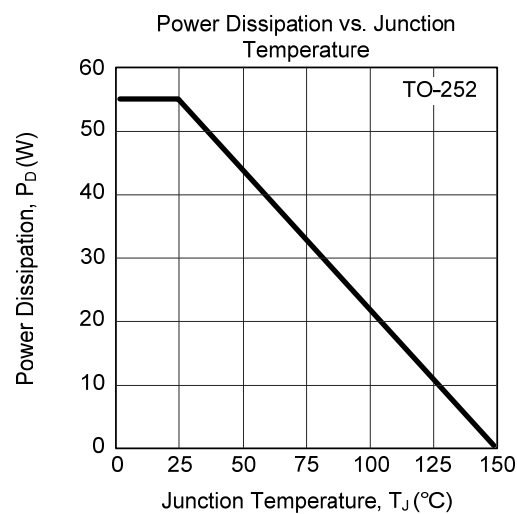
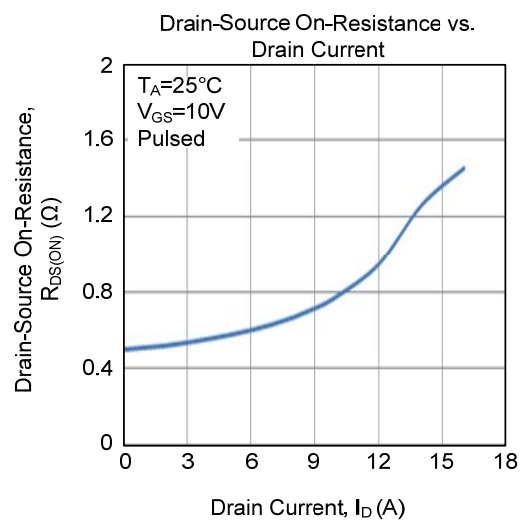
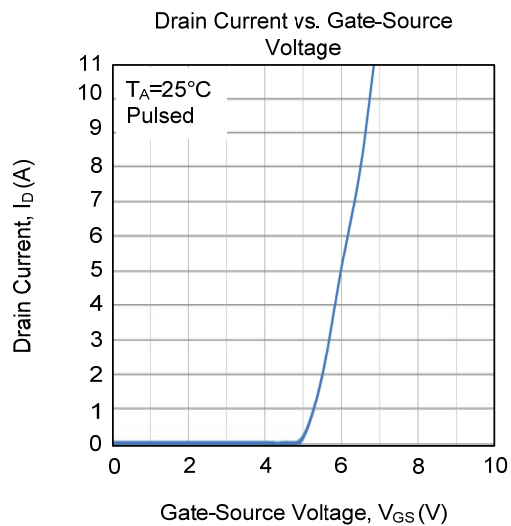
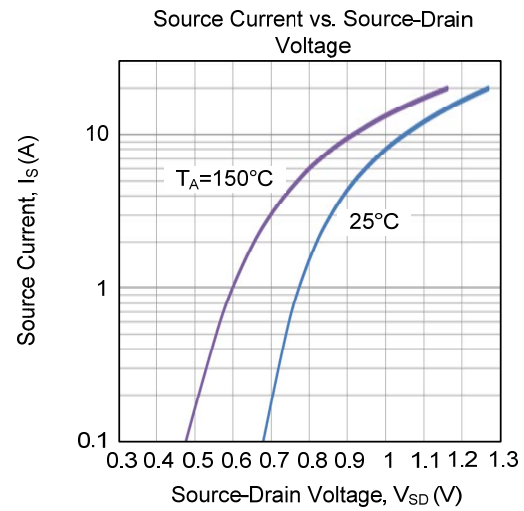
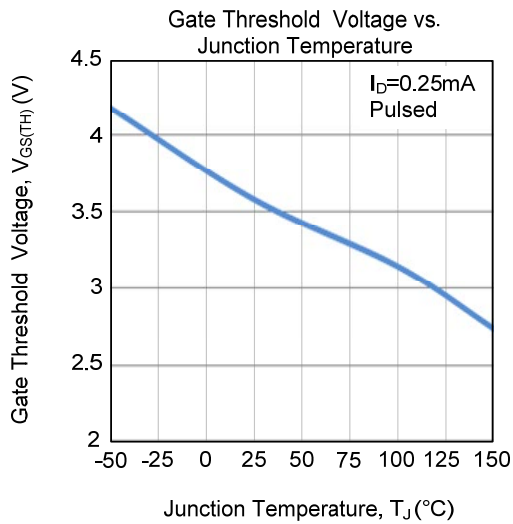


Unclamped Inductive Switching Waveforms

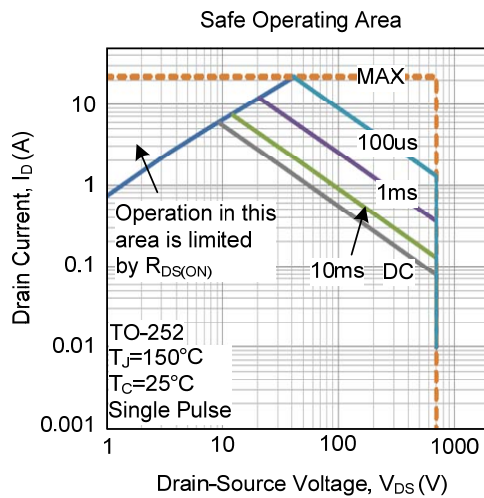
■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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